

Description

Features

- V_{DS}= -40V, I_D= -40A
 - $R_{DS(ON)}$ < 13m Ω @ V_{GS} = -10V

 $R_{DS(ON)} < 22m\Omega$ @ $V_{GS} = -4.5V$

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead free product is acquired

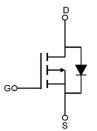
Application

- PWM Applications
- Load Switch
- Power Management

100% UIS 100% ΔVds







Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	OUTLINE	Device Package	Reel Size	Reel (PCS)	Per Carton (PCS)
VSM40P04-T2	VSM40P04	TAPING	TO-252	13inch	2500	25000

Absolute Maximum Ratings (Tc=25℃ unless otherwise specified)

Symbol	Parameter		Max.	Units
V _{DSS}	Drain-Source Voltage		-40	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Continuous Drain Current	T _C = 25 °C	-40	Α
		T _C = 100 ℃	-26	Α
I _{DM}	Pulsed Drain Current note1		-160	Α
Eas	Single Pulsed Avalanche Energy note2		144	mJ
P _D	Power Dissipation	T _C = 25 °C	41.6	W
R _{0JC}	Thermal Resistance, Junction to Case		3.6	°C/W
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	$^{\circ}$ C



Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units		
Off Characteristic								
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D = -250µA	-40	-	-	V		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -40V, V _{GS} =0V	-	-	-1	μA		
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA		
On Characteristics								
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D = -250μA	-1.0	-1.7	-2.5	V		
В	Static Drain-Source on-Resistance	V _{GS} = -10V, I _D = -20A	-	10	13			
$R_{DS(on)}$	note3	V _{GS} = -4.5V, I _D = -10A	-	15	22	mΩ		
Dynamic Characteristics								
C _{iss}	Input Capacitance	\\ - 20\\ \\ -0\\	-	3800	-	pF		
Coss	Output Capacitance	V _{DS} = -20V, V _{GS} =0V, f=1.0MHz	-	329	-	pF		
C _{rss}	Reverse Transfer Capacitance	7 I=1.UIVITZ	-	289	-	pF		
Qg	Total Gate Charge	\/ 00\/ L 00A	-	42	-	nC		
Q _{gs}	Gate-Source Charge	V_{DS} = -20V, I_{D} = -20A, V_{GS} = -10V	-	7.3	-	nC		
Q_{gd}	Gate-Drain("Miller") Charge	7 V _{GS} = -10V	-	8.5	-	nC		
Switching	Characteristics							
t _{d(on)}	Turn-on Delay Time		-	10	-	ns		
t _r	Turn-on Rise Time	V_{DD} = -20V, I_{D} = -20A,	-	21	-	ns		
t _{d(off)}	Turn-off Delay Time	V_{GS} = -10V, R_{GEN} =2.5 Ω	-	53	-	ns		
t _f	Turn-off Fall Time		-	29	-	ns		
Drain-Sou	rce Diode Characteristics and Maxi	mum Ratings						
	Maximum Continuous Drain to Source Diode Forward Current			-	-40	А		
Is								
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	-160	Α		
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S = -30A	-	-0.8	-1.2	V		
trr	Reverse Recovery Time	V _{GS} =0V, I _S = -30A,	-	39	-	ns		
Qrr	Reverse Recovery Charge	di/dt=100A/µs	-	42	-	nC		

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

^{2.} EAS condition: T_J= $25\,^{\circ}$ C, V_{DD}= -20V, V_G= -10V, L= 0.5mH, R_G= 25Ω , I_{AS}= -24A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%



Typical Performance Characteristics

Figure1: Output Characteristics

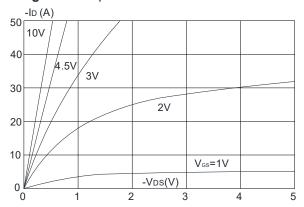


Figure 3:On-resistance vs. Drain Current

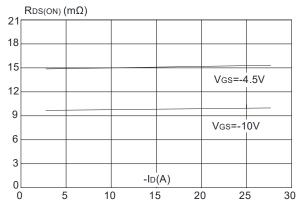


Figure 5: Gate Charge Characteristics

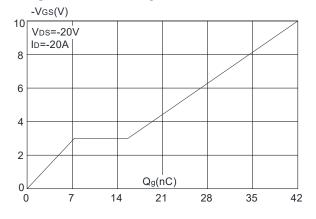


Figure 2: Typical Transfer Characteristics

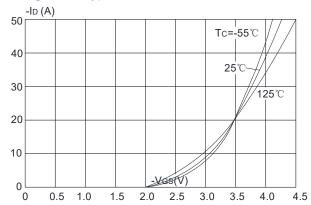


Figure 4: Body Diode Characteristics

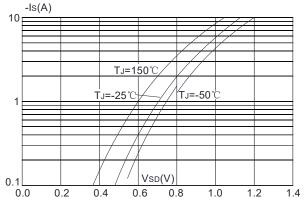


Figure 6: Capacitance Characteristics

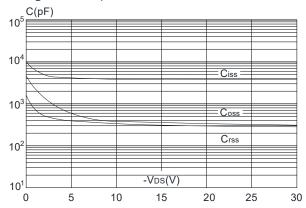




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

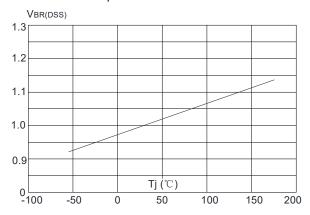


Figure 9: Maximum Safe Operating Area

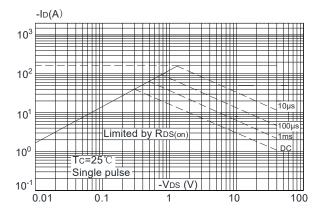


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

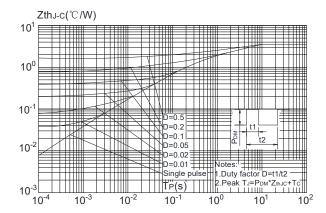


Figure 8: Normalized on Resistance vs. Junction Temperature

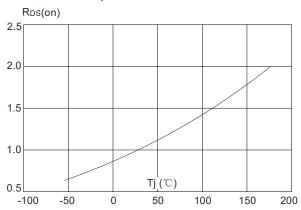
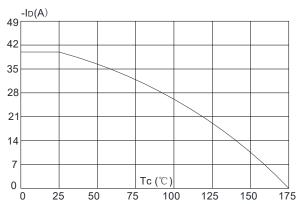


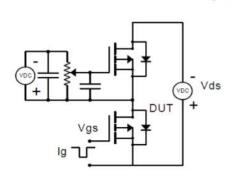
Figure 10: Maximum Continuous Drain Current vs. Case Temperature

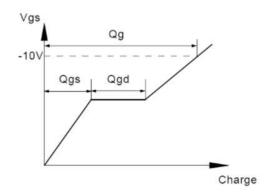




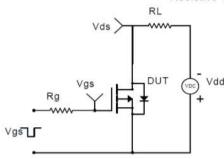
Test Circuit

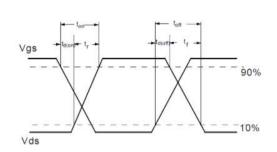
Gate Charge Test Circuit & Waveform



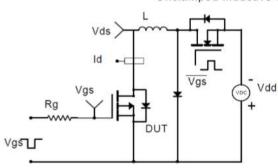


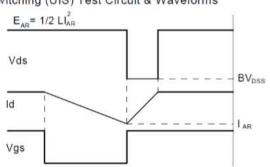
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

